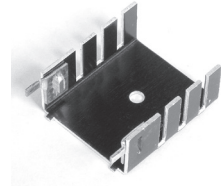


BOARD LEVEL POWER SEMICONDUCTOR HEAT SINKS

206 SERIES

VERTICAL MOUNT HEAT SINK

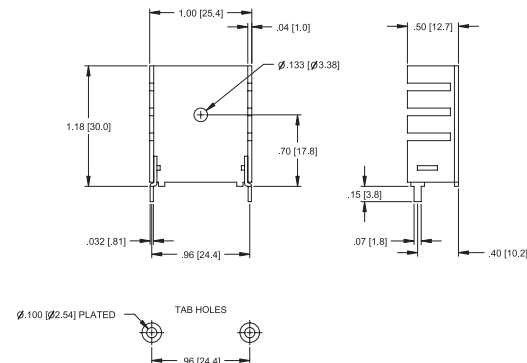
TO-220



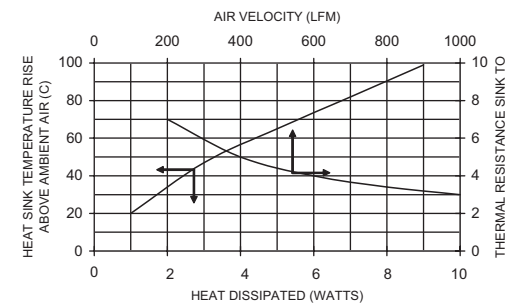
Standard P/N	Height Above PC Board in. (mm)	Maximum Footprint in. (mm)	Thermal Performance at Typical Load	
			Natural Convection	Forced Convection
206-1PABEH	1.18 (30.0)	1.00 (25.4) x .50 (12.7)	56°C rise @ 4W	7.3°C/W @ 200LFM

Material: Aluminum, Black Anodized

MECHANICAL DIMENSIONS



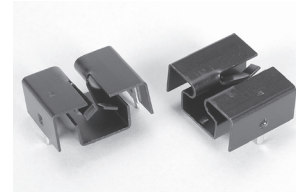
NATURAL AND FORCED CONVECTION CHARACTERISTICS



TO-220

HORIZONTAL MOUNT HEAT SINK

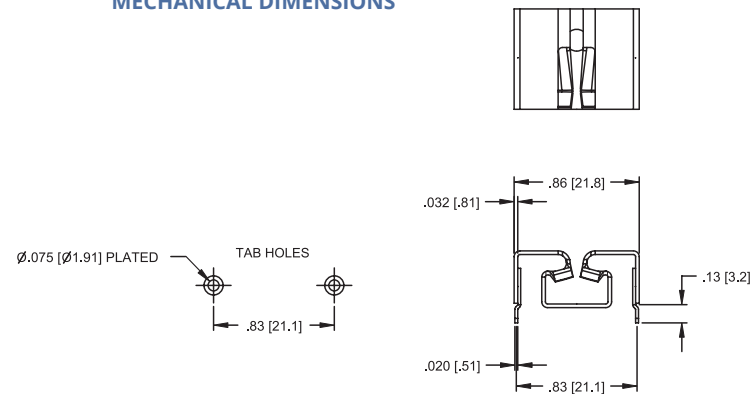
241 SERIES



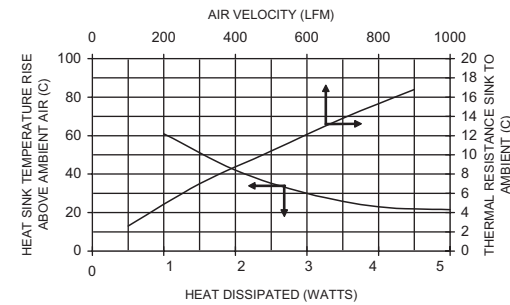
Standard P/N	Height Above PC Board in. (mm)	Maximum Footprint in. (mm)	Thermal Performance at Typical Load	
			Natural Convection	Forced Convection
241-69ABE-03	.39 (9.9)	.86 (21.8) x .69 (17.5)	77°C rise @ 4W	12°C/W @ 200LFM

Material: Aluminum, Black Anodized

MECHANICAL DIMENSIONS



NATURAL AND FORCED CONVECTION CHARACTERISTICS



COMPACT, WAVE-SOLDERABLE LOW-PROFILE SELF-LOCKING HEAT SINKS

230 & 234 SERIES

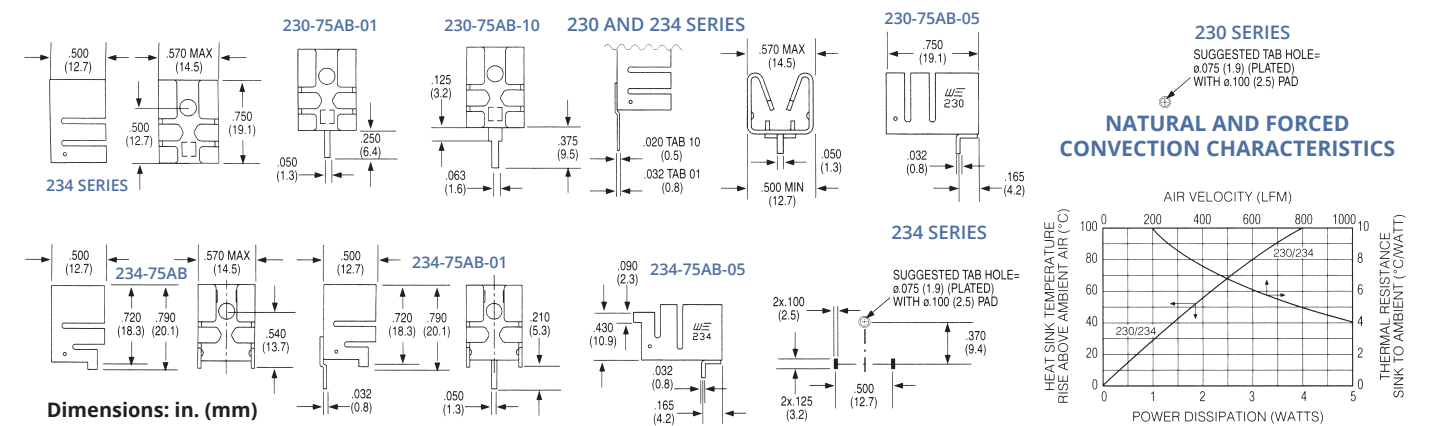


TO-220

Standard P/N	Height Above PC Board in. (mm)	Footprint Dimensions in. (mm)	Mounting Configuration	Solderable Tab Option	Mounting Style	Thermal Performance at Typical Load	
						Natural Convection	Forced Convection
230-75AB	.750 (19.1)	.570 (14.5) x .500 (12.7)	Vert./Horiz.	No Tab	Clip/Mtg Hole	57°C @ 2W	7.5°C/W @ 400 LFM
230-75ABE-01	.750 (19.1)	.570 (14.5) x .500 (12.7)	Vertical	01	Clip/Mtg Hole	57°C @ 2W	7.5°C/W @ 400 LFM
230-75ABE-05	.500 (12.7)	.750 (19.1) x .570 (14.5)	Horizontal	05	Clip/Mtg Hole	57°C @ 2W	7.5°C/W @ 400 LFM
230-75ABE-10	.875 (22.2)	.570 (14.5) x .500 (12.7)	Vertical	10	Clip/Mtg Hole	57°C @ 2W	7.5°C/W @ 400 LFM
234-75AB	.790 (20.0)	.570 (14.5) x .500 (12.7)	Vert./Horiz.	No Tab	Clip/Mtg Hole	57°C @ 2W	7.5°C/W @ 400 LFM
234-75ABE-01	.790 (20.0)	.570 (14.5) x .500 (12.7)	Vertical	01	Clip/Mtg Hole	57°C @ 2W	7.5°C/W @ 400 LFM
234-75ABE-05	.500 (12.7)	.790 (20.0) x .570 (14.5)	Horizontal	05	Clip/Mtg Hole	57°C @ 2W	7.5°C/W @ 400 LFM

Material: Aluminum, Black Anodized

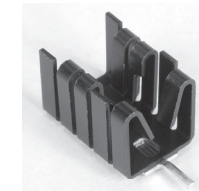
MECHANICAL DIMENSIONS



262 SERIES

HORIZONTAL AND VERTICAL MOUNT HEAT SINK

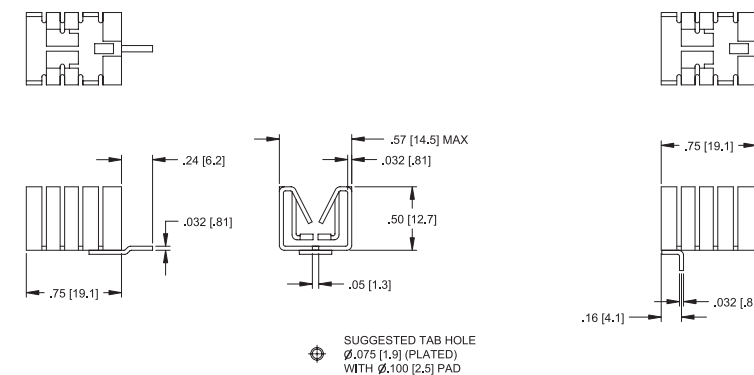
TO-220



Standard P/N	Height Above PC Board in. (mm)	Maximum Footprint in. (mm)	Thermal Performance at Typical Load	
			Natural Convection	Forced Convection
262-75ABE-05	.53 (13.4)	.75 (19.1) x .50 (12.78)	80°C rise @ 2W	10°C/W @ 200LFM
262-75ABE-01	.75 (19.1)	.53 (13.4) x .50 (12.7)	80°C rise @ 2W	10°C/W @ 200LFM

Material: Aluminum, Black Anodized

MECHANICAL DIMENSIONS



NATURAL AND FORCED CONVECTION CHARACTERISTICS

